



Intelligent Compaction

Intelligent Compaction Open House at INDOT

Learn about Intelligent Compaction in 1/2 day



The FHWA/TPF Intelligent Compaction (IC) research team cordially invites you to attend an Open House that showcases HMA IC technologies. The Open House is co-sponsored by the FHWA/Transportation Pooled Fund Intelligent Compaction research team and Asphalt Pavement Association of Indiana. The Open House facility is hosted by Indiana Department of Transportation.



Date: Thur., Sept. 24, 2009

Time: 09:00 AM

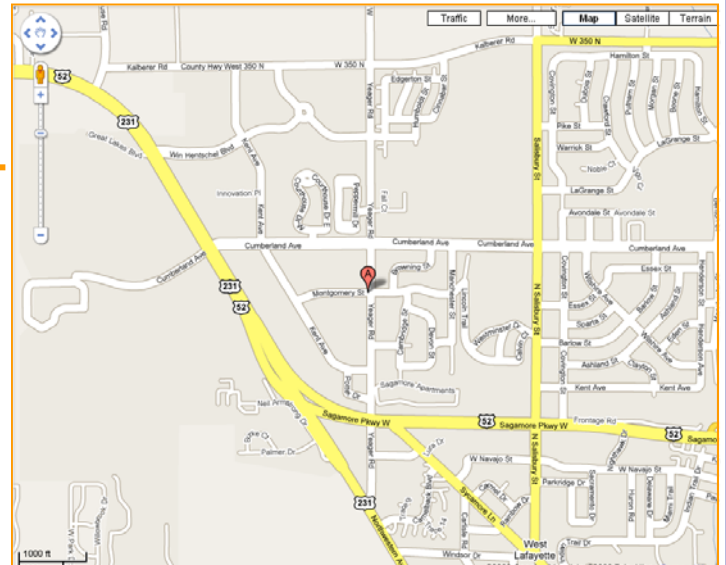
Location:

INDOT / Superpave Center
1205 Montgomery Street, West
Lafayette, IN 47906

Target Audience



State, Federal, Industry, Academia representatives interested in improved HMA construction and quality control activities.



Agenda



Presentation – 9:00 AM to 11:00AM

Indoor presentation of IC technologies and prelim findings by the FHWA/TPF research team, IC roller vendors, and GPS vendors. Refreshments will be provided via the IC team.



Demonstration – 11:00 AM to noon

Outdoor demonstration of IC systems and GPS equipments



Safety

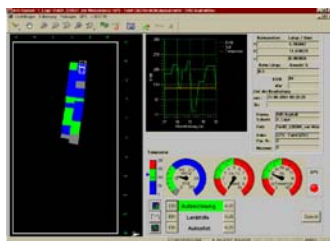
Hard hat, steel-toe boots and safety vest are recommended.

RSVP by Sept 22, 2009

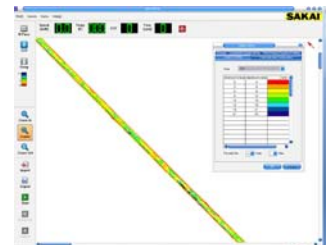
Contact Ruth Calish
Transtec Group
ruth@thetranstecgroup.com
(512) 451-6233

Featured IC Systems

Bomag Double-drum IC System



Sakai Double-drum IC System



www.IntelligentCompaction.com